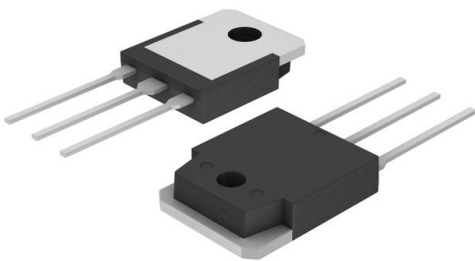


# FCA36N60NF Datasheet

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DiGi Electronics Part Number	FCA36N60NF-DG
Manufacturer	<a href="#">onsemi</a>
Manufacturer Product Number	FCA36N60NF
Description	MOSFET N-CH 600V 34.9A TO3PN
Detailed Description	N-Channel 600 V 34.9A (Tc) 312W (Tc) Through Hole TO-3PN



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## Purchase and inquiry

Manufacturer Product Number:

FCA36N60NF

Series:

FRFET®, SupreMOS®

FET Type:

N-Channel

Drain to Source Voltage (Vdss):

600 V

Drive Voltage (Max Rds On, Min Rds On):

10V

Vgs(th) (Max) @ Id:

5V @ 250µA

Vgs (Max):

±30V

FET Feature:

-

Operating Temperature:

-55°C ~ 150°C (Tj)

Supplier Device Package:

TO-3PN

Base Product Number:

FCA36N60

Manufacturer:

onsemi

Product Status:

Obsolete

Technology:

MOSFET (Metal Oxide)

Current - Continuous Drain (Id) @ 25°C:

34.9A (Tc)

Rds On (Max) @ Id, Vgs:

95mOhm @ 18A, 10V

Gate Charge (Qg) (Max) @ Vgs:

112 nC @ 10 V

Input Capacitance (Ciss) (Max) @ Vds:

4245 pF @ 100 V

Power Dissipation (Max):

312W (Tc)

Mounting Type:

Through Hole

Package / Case:

TO-3P-3, SC-65-3

## Environmental & Export classification

RoHS Status:

ROHS3 Compliant

REACH Status:

REACH Unaffected

HTSUS:

8541.29.0095

Moisture Sensitivity Level (MSL):

Not Applicable

ECCN:

EAR99





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May 2014

## FCA36N60NF

### N-Channel SupreMOS<sup>®</sup> FRFET<sup>®</sup> MOSFET

600 V, 34.9 A, 95 mΩ

#### Features

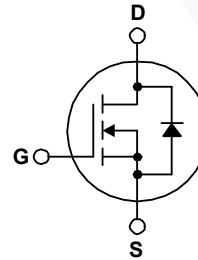
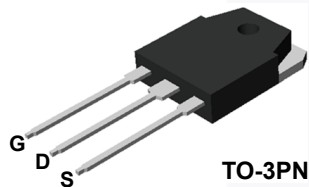
- $R_{DS(on)} = 80 \text{ m}\Omega$  (Typ.) @  $V_{GS} = 10\text{V}$ ,  $I_D = 18 \text{ A}$
- Ultra Low Gate Charge (Typ.  $Q_g = 86 \text{ nC}$ )
- Low Effective Output Capacitance (Typ.  $C_{oss(eff.)} = 338 \text{ pF}$ )
- 100% Avalanche Tested
- RoHS Compliant

#### Application

- Solar Inverter
- AC-DC Power Supply

#### Description

The SupreMOS<sup>®</sup> MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest  $R_{sp}$  on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SupreMOS FRFET<sup>®</sup> MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.



#### MOSFET Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FCA36N60NF	Unit
$V_{DSS}$	Drain to Source Voltage	600	V
$V_{GSS}$	Gate to Source Voltage	$\pm 30$	V
$I_D$	Drain Current	Continuous ( $T_C = 25^\circ\text{C}$ )	34.9
		Continuous ( $T_C = 100^\circ\text{C}$ )	22
$I_{DM}$	Drain Current	Pulsed (Note 1)	104.7
$E_{AS}$	Single Pulsed Avalanche Energy	(Note 2)	1800
$I_{AR}$	Avalanche Current	(Note 1)	12
$E_{AR}$	Repetitive Avalanche Energy	(Note 1)	3.12
dv/dt	MOSFET dv/dt		100
	Peak Diode Recovery dv/dt	(Note 3)	50
$P_D$	Power Dissipation	( $T_C = 25^\circ\text{C}$ )	312
		Derate Above $25^\circ\text{C}$	2.6
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds	300	$^\circ\text{C}$

#### Thermal Characteristics

Symbol	Parameter	FCA36N60NF	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.40	$^\circ\text{C/W}$
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink, Typ.	0.24	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FCA36N60NF	FCA36N60NF	TO-3PN	Tube	N/A	N/A	30 units

## Electrical Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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### Off Characteristics

$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}, T_J = 25^\circ\text{C}$	600	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 1 \text{ mA}, \text{Referenced to } 25^\circ\text{C}$	-	0.60	-	V/°C
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}$ $T_J = 125^\circ\text{C}$	-	-	10 100	$\mu\text{A}$
$I_{GSS}$	Gate to Body Leakage Current	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	-	-	$\pm 100$	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	3.0	3.7	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 18 \text{ A}$	-	80	95	m $\Omega$
$g_{FS}$	Forward Transconductance	$V_{DS} = 20 \text{ V}, I_D = 18 \text{ A}$	-	39	-	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V},$ $f = 1 \text{ MHz}$	-	3191	4245	pF
$C_{oss}$	Output Capacitance		-	145	195	pF
$C_{rss}$	Reverse Transfer Capacitance		-	5	8	pF
$C_{oss}$	Output Capacitance	$V_{DS} = 380 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	81	-	pF
$C_{oss,eff.}$	Effective Output Capacitance	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$	-	338	-	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 380 \text{ V}, I_D = 18 \text{ A},$ $V_{GS} = 10 \text{ V}$	-	86	112	nC
$Q_{gs}$	Gate to Source Gate Charge		-	16	-	nC
$Q_{gd}$	Gate to Drain "Miller" Charge		(Note 4)	-	36	-
ESR	Equivalent Series Resistance (G-S)	$f = 1 \text{ MHz}$	-	1.2	-	$\Omega$

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 380 \text{ V}, I_D = 18 \text{ A},$ $V_{GS} = 10 \text{ V}, R_G = 4.7 \Omega$	-	27	64	ns
$t_r$	Turn-On Rise Time		-	17	44	ns
$t_{d(off)}$	Turn-Off Delay Time		-	92	194	ns
$t_f$	Turn-Off Fall Time		(Note 4)	-	4	18

### Drain-Source Diode Characteristics

$I_S$	Maximum Continuous Drain to Source Diode Forward Current	-	-	36	A	
$I_{SM}$	Maximum Pulsed Drain to Source Diode Forward Current	-	-	108	A	
$V_{SD}$	Drain to Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{SD} = 18 \text{ A}$	-	-	1.2	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{SD} = 18 \text{ A},$ $di_F/dt = 100 \text{ A}/\mu\text{s}$	-	166	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	1.3	-	$\mu\text{C}$

#### Notes:

1. Repetitive rating; pulse-width limited by maximum junction temperature.
2.  $I_{AS} = 12 \text{ A}, R_G = 25 \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 36 \text{ A}, di/dt \leq 1200 \text{ A}/\mu\text{s}, V_{DD} = 380 \text{ V}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature typical characteristics.

### Typical Performance Characteristics

Figure 1. On-Region Characteristics

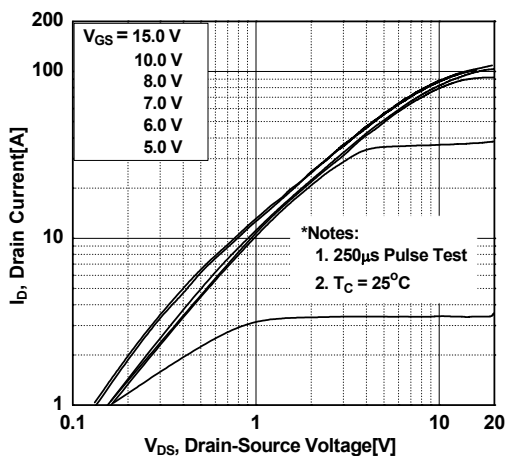


Figure 2. Transfer Characteristics

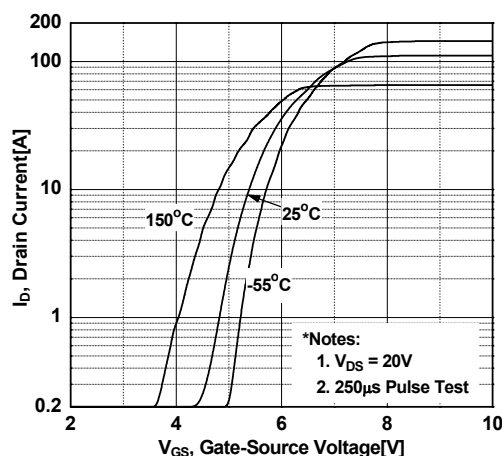


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

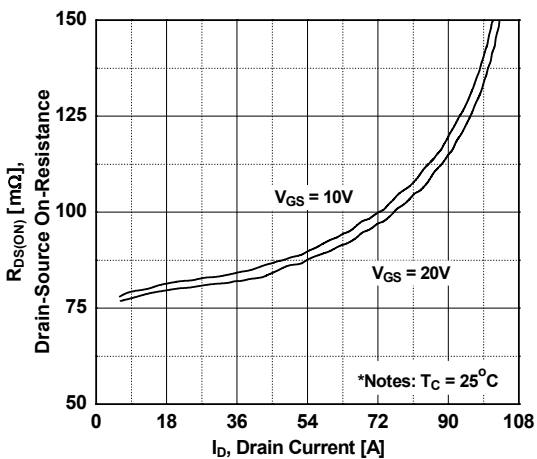


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

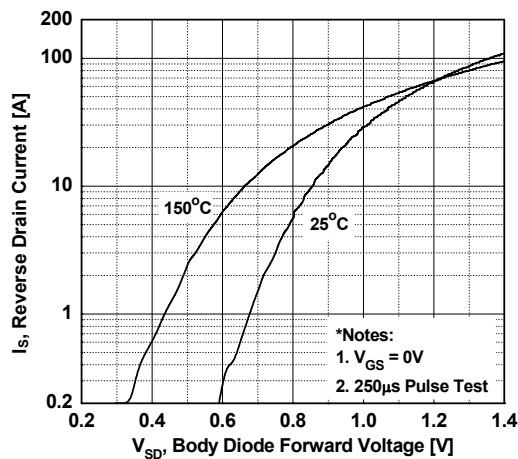


Figure 5. Capacitance Characteristics

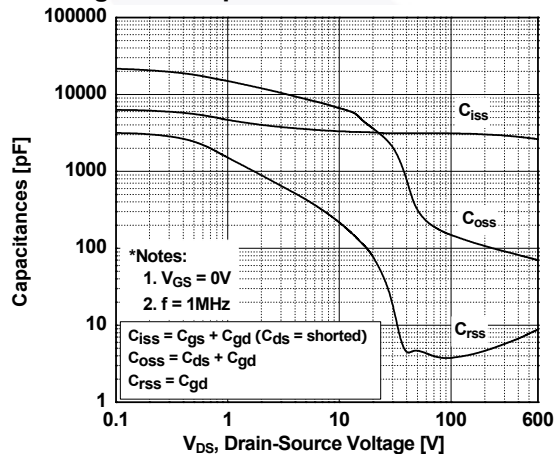
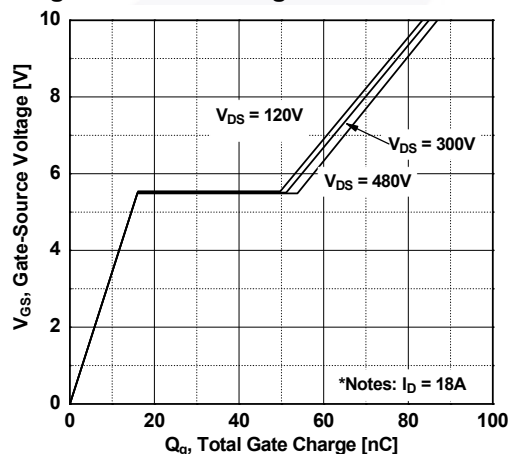


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

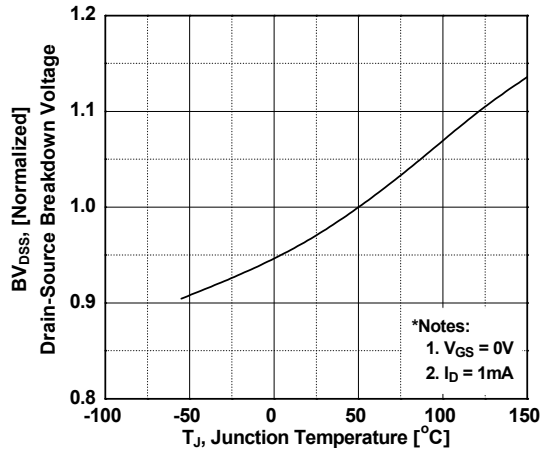


Figure 8. On-Resistance Variation vs. Temperature

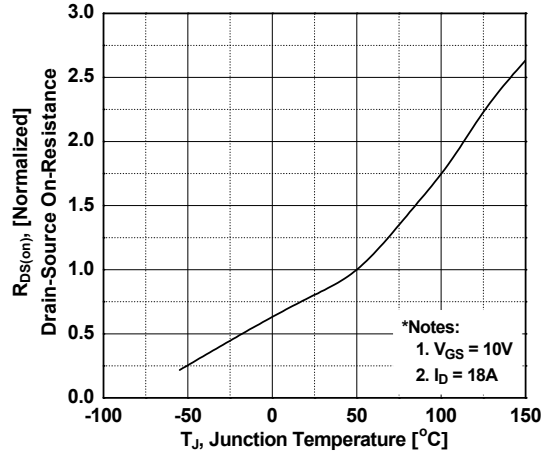


Figure 9. Maximum Safe Operating Area

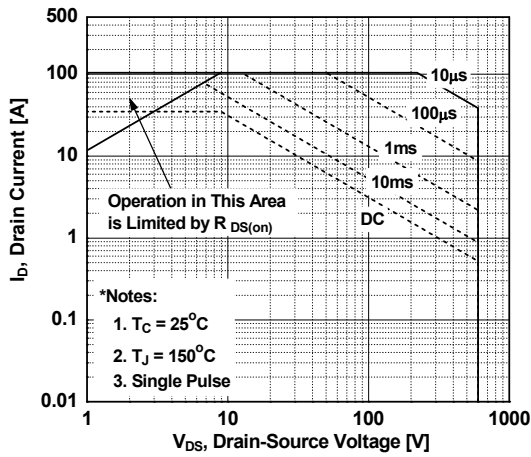


Figure 10. Maximum Drain Current vs. Case Temperature

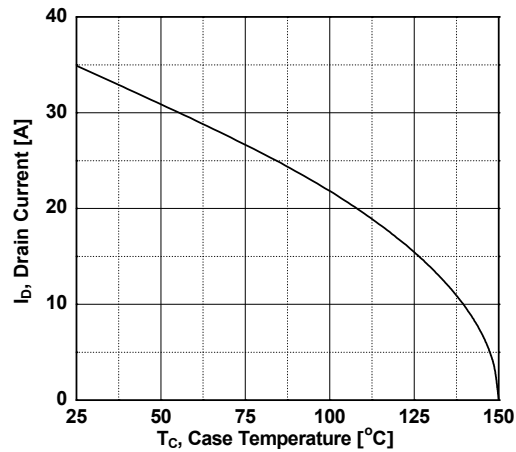
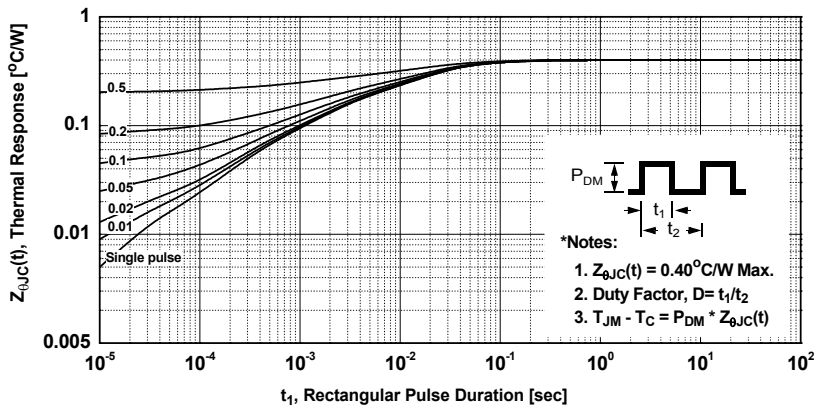


Figure 11. Transient Thermal Response Curve



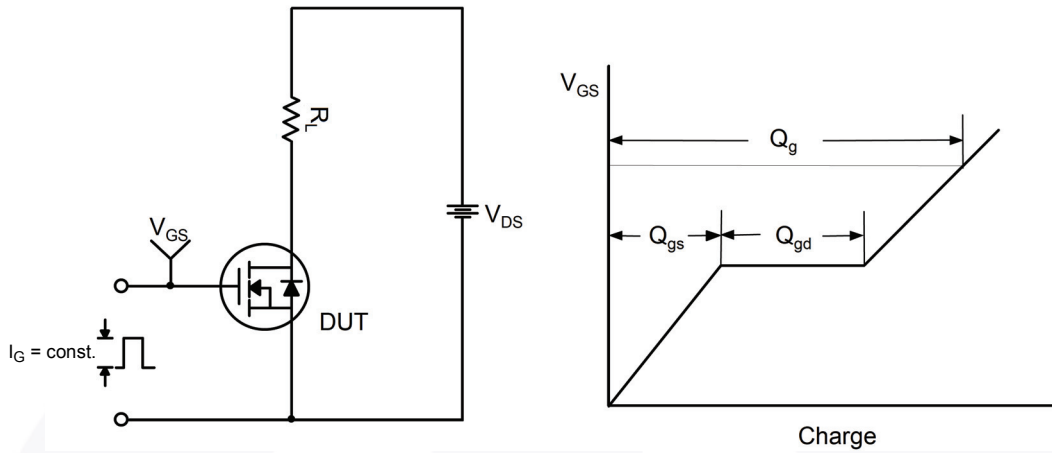


Figure 12. Gate Charge Test Circuit & Waveform



Figure 13. Resistive Switching Test Circuit & Waveforms

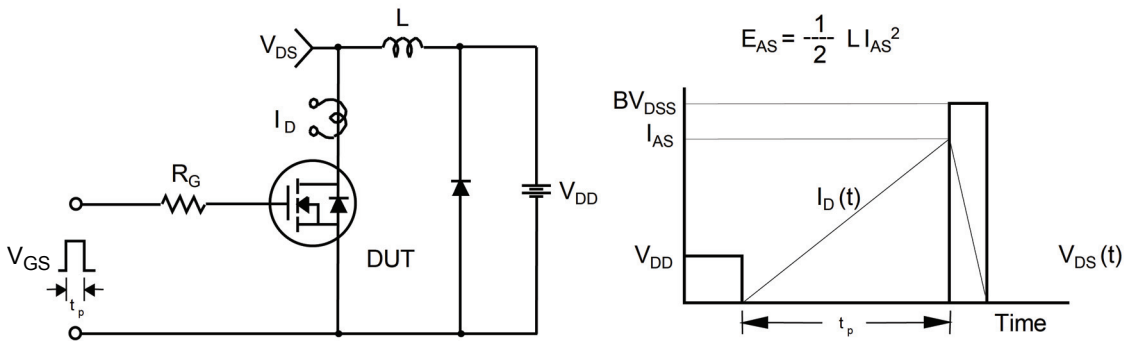


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



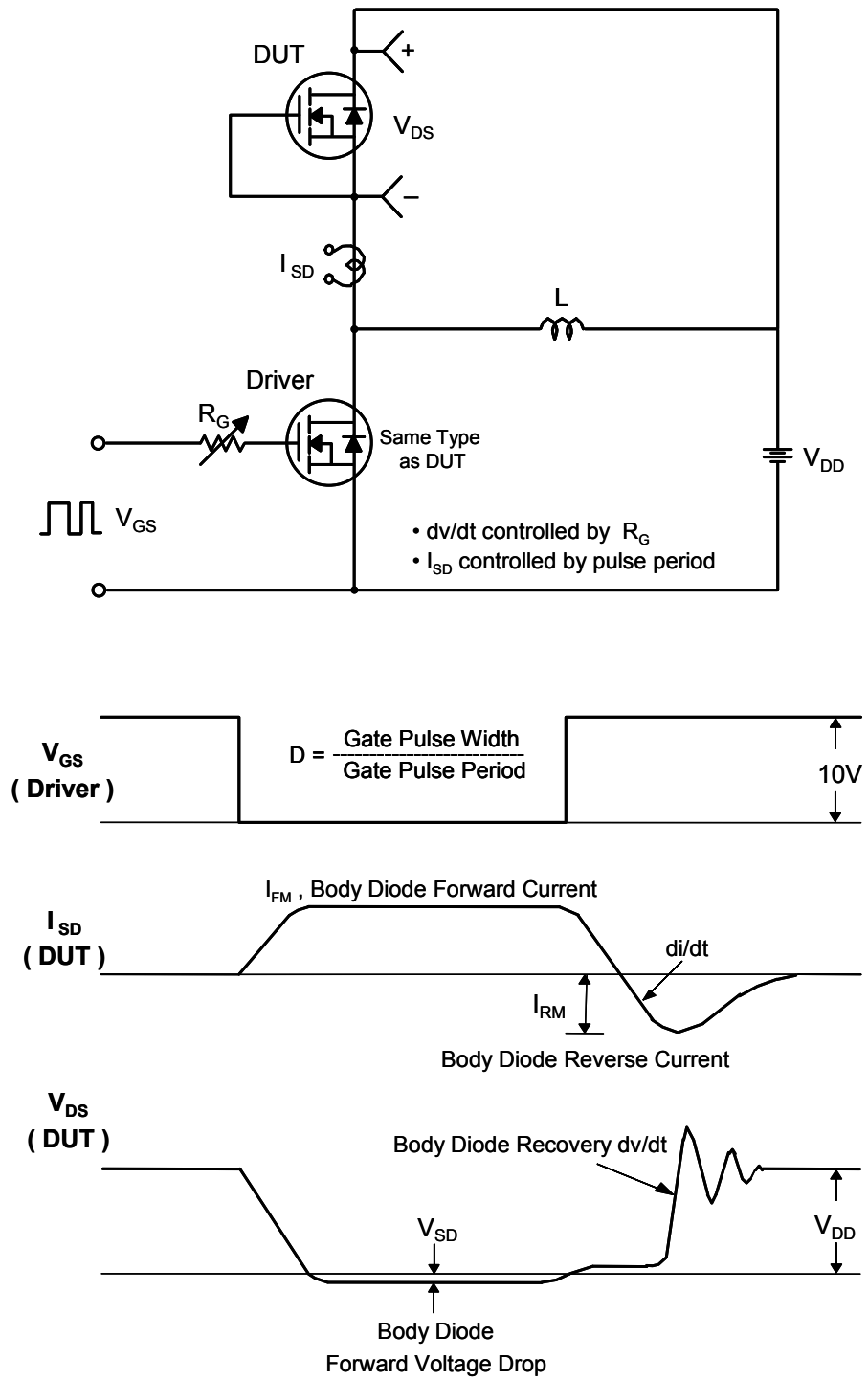
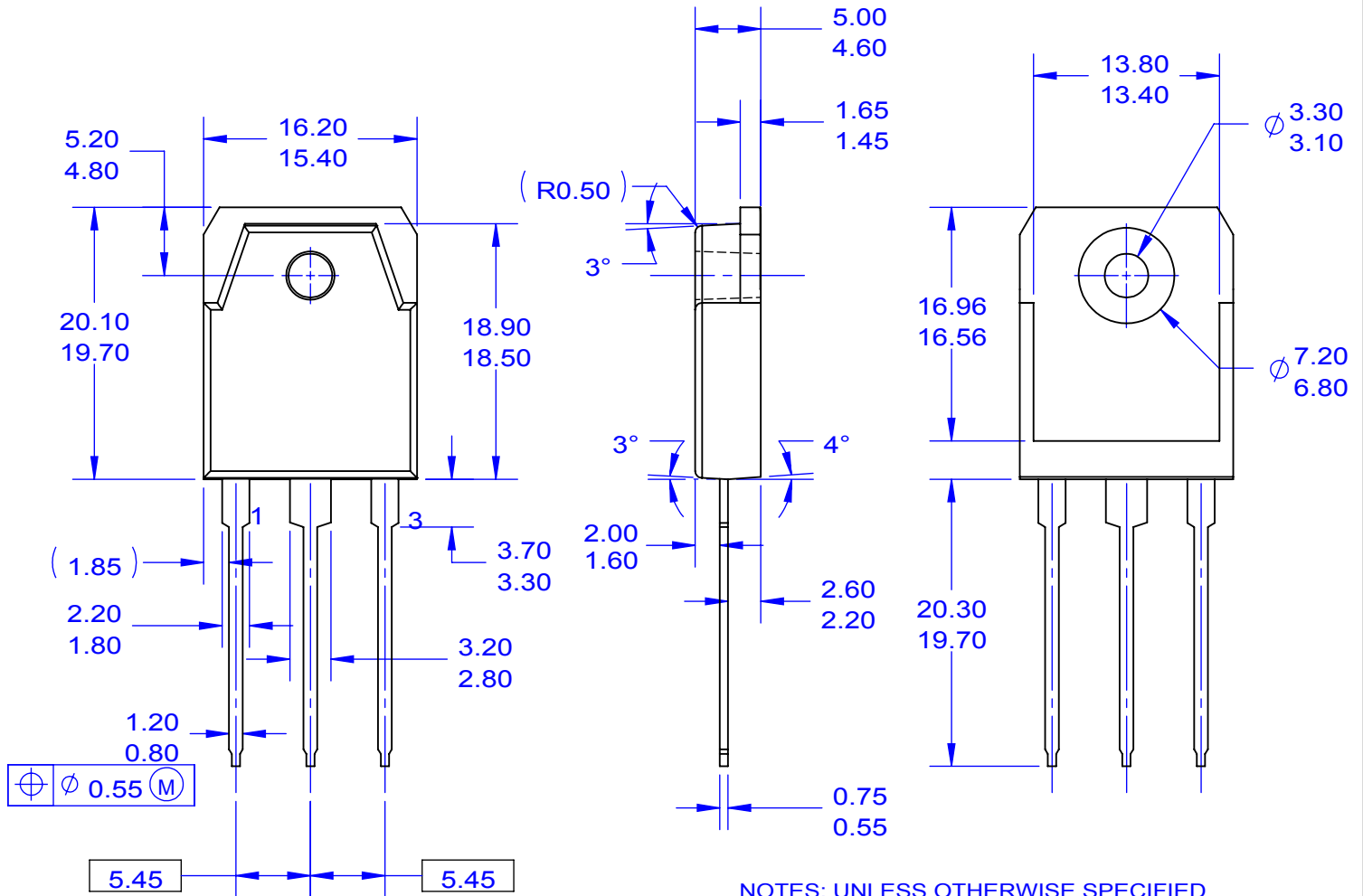



Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms



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